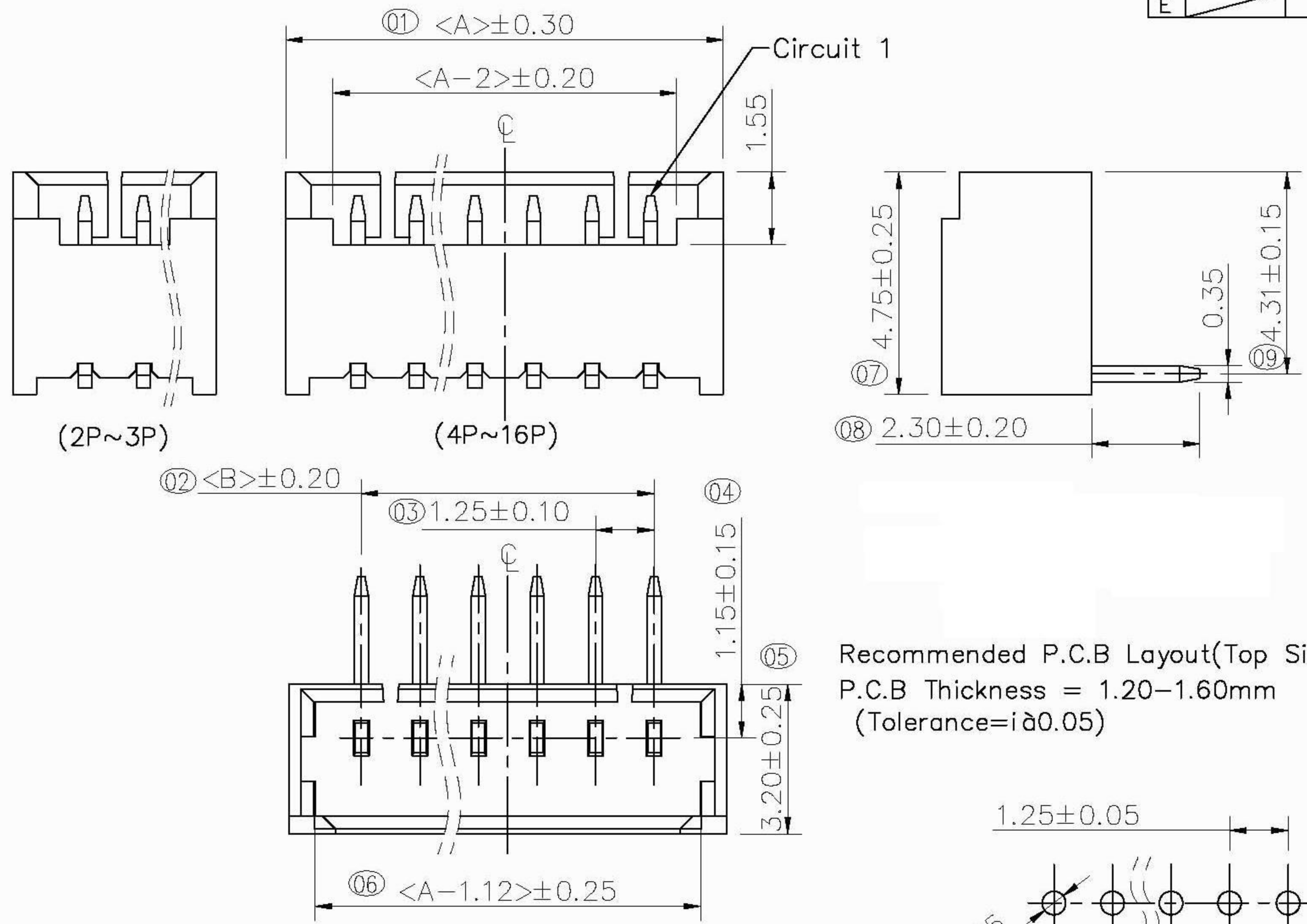


REV.	ECN NO.	DESCRIPTION	DATE	DESIGN
D	NAE09052	新增PA66无卤料号. (X/D)	03/25/09'	姜军广
E		变更料号.	11/04/09'	蓝荣梅



NOTES:
 Current Rating: 1A AC,DC
 Voltage Rating: 125V AC,DC
 Temperature Range: -25°C~+85°C
 Contact Resistance: 20mΩ max
 Insulation Resistance: 500MΩ min
 Withstanding Voltage: 500VAC/minute

PART NO.	Dimensions	
	A	B
WF1250R02	4.25	1.25
WF1250R03	5.50	2.50
WF1250R04	6.75	3.75
WF1250R05	8.00	5.00
WF1250R06	9.25	6.25
WF1250R07	10.50	7.50
WF1250R08	11.75	8.75
WF1250R09	13.00	10.00
WF1250R10	14.25	11.25
WF1250R11	15.50	12.50
WF1250R12	16.75	13.75
WF1250R13	18.00	15.00
WF1250R14	19.25	16.25
WF1250R15	20.50	17.50
WF1250R16	21.75	18.75

共用件 Wafer-T	A1250TRB000	BRASS T=0.30	Ni: 30-50u*MIN; SN: 70-120u*MIN
Wafer-胶芯	A1250DPXX3	PA66 UL 94V-0	无卤本色
Wafer-胶芯	A1250DPXX2	PA66+30%GF UL 94V-0	无卤本色
Wafer-胶芯	A1250DPXX1	PA66+30%GF UL 94V-0	本色
Wafer-胶芯	A1250DPXX0	PA6T UL 94V-0	本色
PART NAME	PART No.	MATERIALS	SPEC

DIM	TOL	DIM	TOL
X.	/	X°	/
X.X	±0.25	X.X°	±2°
X.XX	±0.20	X.XX°	±1°
X.XXX	±0.10	X.XXX°	/

GXCON ENTERPRISE CO., LTD			
DRAW NO.	DATE	P/N NO.	DRAW NAME
DESIGN		WF1250RXX	MX 1.25 90° DIP Wafer
CHECK			
REVIEW		REV. D	SCALE 1:1
		UNIT: mm	SHEET 1 OF 1